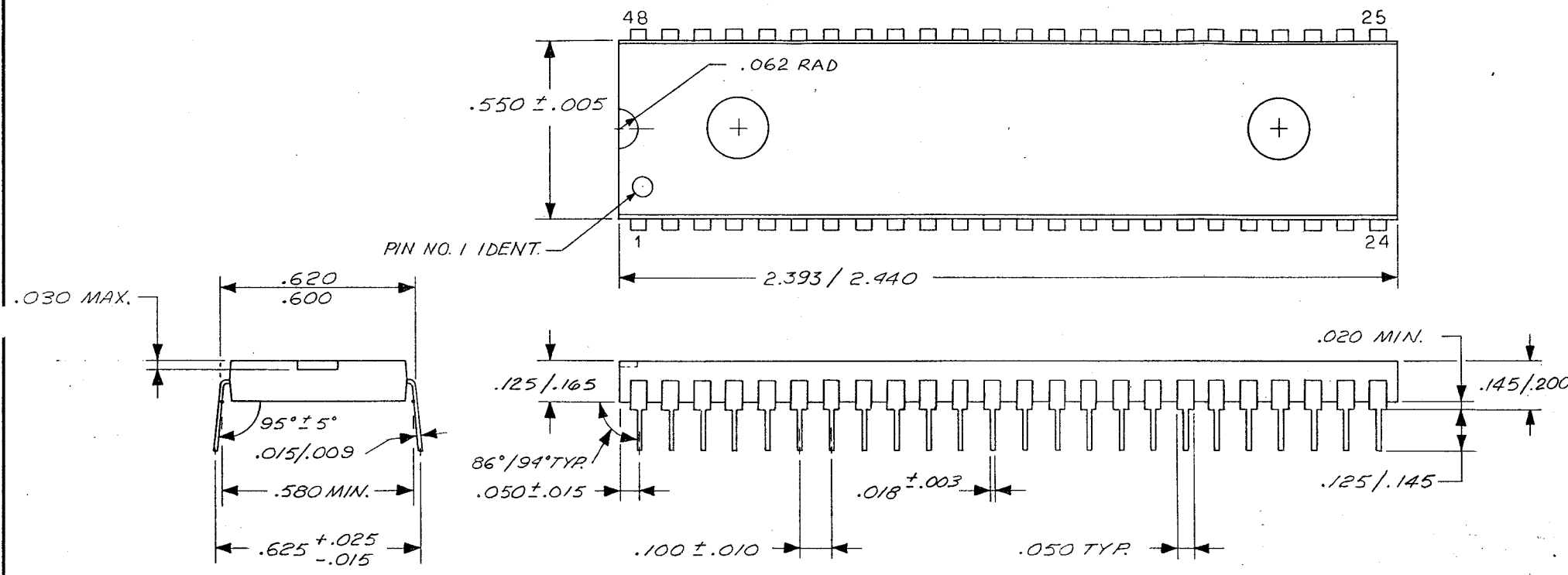



REVISIONS					
REV.	SHEET	DESCRIPTION	E.C.O.	DATE	APPROVED
A	1	NEW DWG (REDRAWN)	0520	11-2-81	T.S.
B	1	CHANGED DIM. WAS .130 ± .005 TO .125/.165	07524	10/1/82	T Spellman
C	1	ADDED EJECTOR PINS	00108	7/19/83	T Spellman
D	1	PKG LENGTH WAS 2.440 MAX, ADDED .145/.200 DIM., DELETED .060, CHANGED .125 MIN TO .125/.145	00848	11-29-83	T Spellman



STANDARD LEAD FINISH:  
 200 μ INCHES MINIMUM LEAD/TIN 37/63  
 ON ALLOY 42 OR EQUIVALENT, OR COPPER.

<b>COMPANY PRIVATE</b>				 <b>National Semiconductor Corporation</b> 2900 Semiconductor Drive, Santa Clara, Calif. 95051	
DRAWN: E. VAN HOOK	DATE: 11-2-81	APPROVED: <i>T Spellman</i>	DATE: 11/2/81	<b>48 LEAD          MOLDED DIP (N)</b>	
CHECKED:	DATE:	APPROVED: <i>T Spellman</i>	DATE: 11-3-81		
ENGINEER: T SPELLMAN	DATE: 11/2/81	RELEASED:	DATE:	<b>B</b>	<b>MKT-N48A</b>
				SHEET	OF
				REV.	<b>D</b>